

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT | | | | | | | | |
|---|--------------------------------|---------------|----------------|---------------------|------------|-----------------|------------|----------------|------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT | | | | | | | | |
| CONVEYING PARTY DATA | | | | | | | | | |
| <table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Mark A Gerber</td> <td>05/08/2006</td> </tr> <tr> <td>Kurt P Wachtler</td> <td>05/19/2006</td> </tr> <tr> <td>Abram M Castro</td> <td>05/22/2006</td> </tr> </tbody> </table> | | Name | Execution Date | Mark A Gerber | 05/08/2006 | Kurt P Wachtler | 05/19/2006 | Abram M Castro | 05/22/2006 |
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| Mark A Gerber | 05/08/2006 | | | | | | | | |
| Kurt P Wachtler | 05/19/2006 | | | | | | | | |
| Abram M Castro | 05/22/2006 | | | | | | | | |
| RECEIVING PARTY DATA | | | | | | | | | |
| Name: | Texas Instruments Incorporated | | | | | | | | |
| Street Address: | P.O. Box 655474 MS 3999 | | | | | | | | |
| City: | Dallas | | | | | | | | |
| State/Country: | TEXAS | | | | | | | | |
| Postal Code: | 75265 | | | | | | | | |
| PROPERTY NUMBERS Total: 1 | | | | | | | | | |
| <table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11380953</td> </tr> </tbody> </table> | | Property Type | Number | Application Number: | 11380953 | | | | |
| Property Type | Number | | | | | | | | |
| Application Number: | 11380953 | | | | | | | | |
| CORRESPONDENCE DATA | | | | | | | | | |
| Fax Number: | (972)917-4418 | | | | | | | | |
| <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> | | | | | | | | | |
| Phone: | 9729175355 | | | | | | | | |
| Email: | k-vertz@ti.com | | | | | | | | |
| Correspondent Name: | Texas Instruments Incorporated | | | | | | | | |
| Address Line 1: | P.O. Box 655474 MS 3999 | | | | | | | | |
| Address Line 4: | Dallas, TEXAS 75265 | | | | | | | | |
| ATTORNEY DOCKET NUMBER: | TI-61426 | | | | | | | | |
| NAME OF SUBMITTER: | Yingsheng Tung | | | | | | | | |
| Total Attachments: 1 source=TI61426Assignment#page1.tif | | | | | | | | | |

CH \$40.00 11380953

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

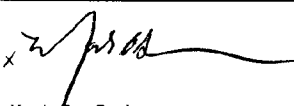
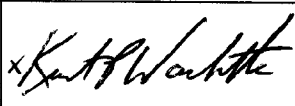
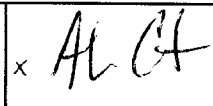
WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

| | | | |
|--------------------------------|---|--|--|
| TITLE OF INVENTION | Semiconductor Package-on-Package System Including Integrated Passive Components | | |
| SIGNATURE OF INVENTOR AND NAME |  Mark A. Gerber |  Kurt P. Wachtler |  Abram M. Castro |
| DATE OF SIGNATURE | X 5/8/06 | X 5/19/06 | X 5/22/06 |
| RESIDENCE (City, State) | Lucas, Texas | Richardson, Texas | Fort Worth, Texas |
| DATE APPLICATION EXECUTED | | | |

After recording Assignment, please return to:

Yingsheng Tung
Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265

PATENT

RECORDED: 07/06/2006

REEL: 017885 FRAME: 0820